BR25G128F-3GE2 Information

For Reference Only

Part Number	BR25G128F-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Description	SPI BUS EEPROM
Package	8-SOIC (0.173", 4.40mm Width)

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

BR25G128F-3GE2 Specifications

Manufacturer Part Number	BR25G128F-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Package	8-SOIC (0.173", 4.40mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	128Kb (16K x 8)
Memory Interface	SPI
Clock Frequency	20MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.6 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.173", 4.40mm Width)
Supplier Device Package	8-SOP
	Report errors?

BR25G128F-3GE2 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

BR25G128F-3GE2 Payment Methods

BR25G128F-3GE2 Shipping Methods

If you have any question about BR25G128F-3GE2, please do not hesitate to contact us!
Website: https://www.heisener.com
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